

A new three-channel relay driver circuit that

#### 1.Description

ULN2001D is a single-chip integrated high voltage, high current Darlington transistor array, which contains three independent Darlington transistor drive channels inside the circuit. The circuit is internally designed with a freewheeling diode, which can be used to drive inductive loads such as relay stepper motors. A single Darlington tube collector can output a current of 500mA, and connecting multiple channels in parallel can achieve higher current output capabilities. This circuit can be widely used in relay drive, lighting drive, display screen drive (LED), stepper motor drive, and logic buffer.

#### 2.Features

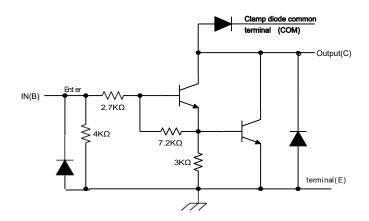
- 500mA collector output current (single circuit)
- High voltage resistance (50V)
- Input compatible TTL/CMOS logic signal
- Widely used in relay drive
- ULN2001D input port integrates 4K pull-down resistance to ground

### 3.Applications

- Relay drive
- Indicator light driver

Display screen driver

### 4. Circuit Schematic (Single Darlington Driver Circuit)

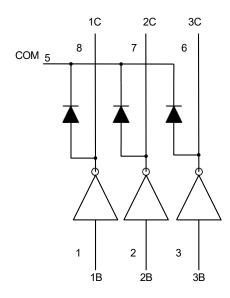


Schematic diagram of ULN2001D single circuit Darlington drive circuit





## **5.Logic Diagram**



#### Pin Descriptions

Pin Number	Pin Names	Input/Output	Description
1	1B	I	1-channel input pin
2	2B	I	2-channel input pin
3	3B	I	3-channel input pin
4	E	-	Grounding
5	СОМ	-	Clamp diode common
6	3C	0	3-channel output pin
7	2C	0	2-channel output pin
8	1C	0	1-channel output pin





## 6.Absolute Maximum Rating (T<sub>A</sub>=25°C, unless otherwise specified)

Parameter	Symbol	value	Units	
Collector emitter voltage (6-8 pins)		V <sub>CE</sub>	50	V
COM terminal voltage (5 pins)		V <sub>COM</sub>	50	V
Input voltage (1-3 pins)		Vı	30	V
Single collector peak current	I <sub>CP</sub>	500	mA	
Output clamp diode forward peak current	I <sub>OK</sub>	500	mA	
Maximum peak current of the total emitter		I <sub>ET</sub>	-1.5	Α
Packaging thermal impedance (1)(2)(3)	$\theta_{JA}$	160	°C/W	
Maximum operating junction temperature		TJ	150	°C
Welding temperature		260	10s	
Storage temperature range		T <sub>STG</sub>	-65 to 150	°C

Note: 1. The maximum power consumption can be calculated according to the following relationship,  $P_D = (T_J - T_A)/\theta_{JA}$ 

<sup>2.</sup> T<sub>J</sub> represents the junction temperature at which the circuit operates, and T<sub>A</sub> represents the ambient temperature at which the circuit operates



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### 7. Recommended Operating Conditions

(T<sub>A</sub>=25°C, unless otherwise specified)

Parameter	Symbol	Conditions	Min	Max	Units
Output terminal voltage	V <sub>CE(SUS)</sub>		0	50	V
Output current	I <sub>OUT</sub>	Continuous output, T <sub>A</sub> =85°C		100	mA/ch
Input Voltage	V <sub>IN</sub>		0	12	V
Input voltage (output turned on)	V <sub>IN(ON)</sub>	I <sub>OUT</sub> =400mA	2.8	12	V
Input voltage (output shutdown)	$V_{IN(OFF)}$		0	0.7	V
Clamp diode reverse voltage	$V_R$			50	V
Clamp diode forward peak current	I <sub>F</sub>			350	mA
Working temperature range	T <sub>A</sub>		-40	85	°C
Working temperature	TJ		-40	125	°C
Dissipative power consumption	P <sub>D</sub>	T <sub>A</sub> =25°C		0.625	W
SOP8	r <sub>D</sub>	T <sub>A</sub> =85°C		0.25	W

Note: 1. T<sub>A</sub> represents the ambient temperature at which the circuit operates

2. The calculation method for circuit power consumption is:

 $\mathsf{P}_{\mathsf{D}} \!\!=\!\! \mathsf{V}_{\mathsf{CE}(\mathsf{ON})1} \!\!\times\! \mathsf{I}_{\mathsf{C1}} \!\!+\! \mathsf{V}_{\mathsf{CE}(\mathsf{ON})2} \!\!\times\! \mathsf{I}_{\mathsf{C2}} \!\!+\! \mathsf{V}_{\mathsf{CE}(\mathsf{ON})3} \!\!\times\! \mathsf{I}_{\mathsf{C3}} + \mathsf{V}_{\mathsf{IN1}} \!\!\times\! \mathsf{I}_{\mathsf{IN1}} \!\!+\! \mathsf{V}_{\mathsf{IN2}} \!\!\times\! \mathsf{I}_{\mathsf{IN2}} \!\!+\! \mathsf{V}_{\mathsf{IN3}} \!\!\times\! \mathsf{I}_{\mathsf{IN3}}$ 

3. Note 2  $V_{CE\ (ON)n}$  represents the conduction voltage drop of the corresponding channel, where n=1,2,3;

IC Represents the average load current of the corresponding channel, where n=1,2,3;

V<sub>INn</sub>Represents the average high-level input signal of the corresponding channel, where n=1,2,3;

I<sub>INn</sub>Represents the average input current of the corresponding channel's signal, where n=1,2,3;

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### **8. Electrical Parameter Characteristic Table**

(T<sub>A</sub>=25°C, unless otherwise specified)

Parameter	Test Chart	Co	nditions	Min.	Тур.	Max.	Units	
				I <sub>C</sub> =30mA		1.73	2.1	
				I <sub>C</sub> =60mA		1.76	2.1	
			T <sub>A</sub> =0°C	I <sub>C</sub> =120mA		1.8	2.2	
				I <sub>C</sub> =240mA		1.88	23	
		V <sub>CE</sub> =1.5V		I <sub>c</sub> =350mA		2	2.4	
		(Input unrestricted)		I <sub>C</sub> =30mA		1.63	2	
				I <sub>C</sub> =60mA		1.66	2	V
	Figure 2		T <sub>A</sub> =25°C	I <sub>C</sub> =120mA		1.69	2.1	
				I <sub>C</sub> =240mA		1.76	2.2	
V <sub>I(ON)</sub> Conduction state				I <sub>c</sub> =350mA		1.87	2.3	
input voltage			T <sub>A</sub> =0°C	I <sub>C</sub> =30mA		2.21	2.65	
				I <sub>C</sub> =60mA		2.25	2.7	
				I <sub>C</sub> =120mA		2.3	2.76	
				I <sub>C</sub> =240mA		2.42	2.9	
		I <sub>I</sub> =800uA		I <sub>C</sub> =350mA		2.55	3.06	
		(V <sub>CE</sub> <1.5V)		I <sub>C</sub> =30mA		2.25	2.7	
				I <sub>C</sub> =60mA		2.28	2.74	
			T <sub>A</sub> =25°C	I <sub>C</sub> =120mA		2.33	2.8	
				I <sub>C</sub> =240mA		2.44	2.93	
				I <sub>C</sub> =350mA		2.57	3.08	

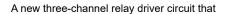






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Parameter	Test Chart	C	onditions		Min.	Тур.	Max.	Units
				I <sub>C</sub> =30mA		2.54	3.05	
				I <sub>c</sub> =60mA		2.58	3.1	]
			T <sub>A</sub> =0°C	I <sub>C</sub> =120mA		2.64	3.17	
				I <sub>C</sub> =240mA		2.77	3.32	
V <sub>I(ON)</sub> Conduction state	Figure 2	I <sub>I</sub> =1mA		I <sub>c</sub> =350mA		2.91	3.49	
input voltage	r igure z	(V <sub>CE</sub> <1.5V)		I <sub>C</sub> =30mA		2.6	3.12	
				I <sub>c</sub> =60mA		2.64	3.17	
			T <sub>A</sub> =25°C	I <sub>C</sub> =120mA		2.7	3.24	V
				I <sub>C</sub> =240mA		2.83	3.4	
				I <sub>C</sub> =350mA		2.98	3.58	
	Figure 2		T <sub>A</sub> =0°C	I <sub>C</sub> =30mA		0.8		
				I <sub>c</sub> =60mA		0.85		
				I <sub>C</sub> =120mA		0.93		
V Collector				I <sub>C</sub> =240mA		1.09		
V <sub>CE(SAT)</sub> Collector emitter saturation voltage drop		V <sub>i</sub> =2.4V		I <sub>C</sub> =350mA		1.27		
	Figure 3	(I <sub>I</sub> >800uA)		I <sub>c</sub> =30mA		0.75		
				I <sub>c</sub> =60mA		0.8		
			T <sub>A</sub> =25°C	I <sub>C</sub> =120mA		0.87		
				I <sub>C</sub> =240mA		1.03		
				I <sub>C</sub> =350mA		1.2		





Parameter	Symbol	С	onditions	;	Min.	Тур.	Max.	Units
				V <sub>I</sub> =12V		6.6		-
			T -0°C	V <sub>I</sub> =6V		3.1		
			T <sub>A</sub> =0°C	V <sub>1</sub> =4.5V		2.04		
Innut Current (Figure 2)	,	L =60=4		V <sub>I</sub> =2.4V		0.84		mA
Input Current (Figure 2)	I <sub>t</sub>	I <sub>C</sub> =60mA		V <sub>I</sub> =12V		6.3		IIIA
			T <sub>A</sub> =25°C	V <sub>I</sub> =6V		2.8		
			1 <sub>A</sub> -25 C	V <sub>1</sub> =4.5V		1.97		
				V <sub>1</sub> =2.4V		0.83		
Clamp diode forward		T <sub>A</sub> =0°C			1.4	1.6	1.6 V	
voltage drop (Figure 5)	$V_{F}$	I <sub>F</sub> =350mA	T <sub>A</sub> =25°C			1.4	1.6	
Collector turn off leakage						50		
current (Figure 1)	I <sub>CEX</sub>	V <sub>CE</sub> =50V, I <sub>i</sub> =0					50	μA
Collector withstand voltage				50			V	
(Figure 1)	$V_{\sf CE}$	V <sub>CE</sub> =50V, I <sub>I</sub>	=0		50			V
Clamp diode reverse leakage							50	
current (Figure 4)	I <sub>R</sub>	V <sub>R</sub> =50V					30	μA
Low high transmission delay		) / 40) / D	450			0.45	4	
(Figure 6)	t <sub>PLH</sub>	V <sub>L</sub> =12V, R <sub>L</sub>	_=45Ω			0.15	1	μs
Transmission delay high low		1/ 401/ 5	450			0.45	4	
(Figure 6)	t <sub>PHL</sub>	V <sub>L</sub> =12V, R <sub>L</sub>	_=45Ω			0.15	1	μs



## 9. Electrical Parameter Testing Schematic Diagram

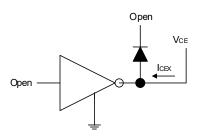


Figure 1. I<sub>CEX</sub> Test Circuit

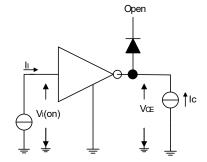


Figure 2.  $I_{I}$  and  $V_{I(ON)}$  Test Circuit

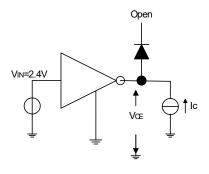


Figure 3.  $V_{\text{CE(sat)}}$  Test Circuit

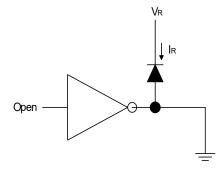


Figure 4. I<sub>R</sub> Test Circuit

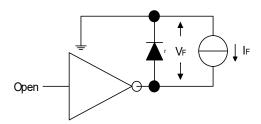


Figure 5. V<sub>F</sub> Test Circuit



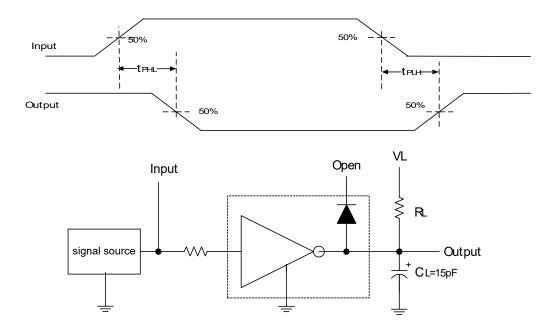
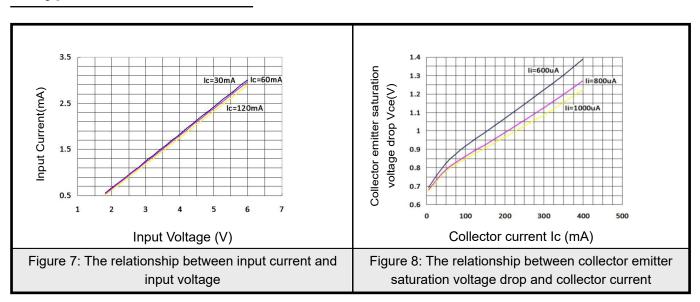


Figure 6. Transmission delay waveform

Note: The capacitive load in Figure 6 is the parasitic capacitance of the oscilloscope probe.

### 10. Typical Characterisitics





### 11.Application Information

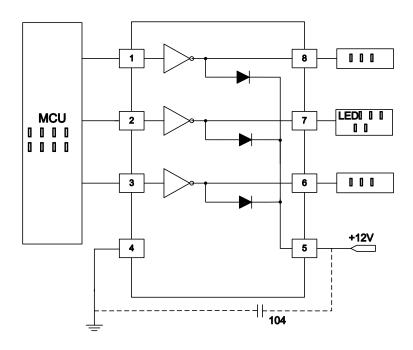


Figure 10. ULN2001D application circuit diagram

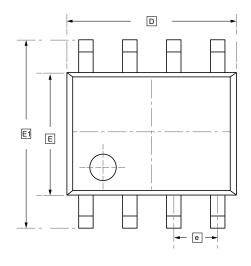
The application of ULN2001D is not limited to the application circuit diagram shown in Figure 10. In particular, the load of the drive circuit can be 3 relays, 3 LED, or 2 outputs can be used in parallel as 1 circuit. The specific application depends on the actual situation.

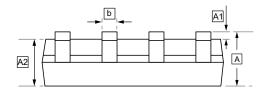
ULN2001D has built-in 4K pull-down resistance to ground, so no external pull-down resistance is required during use.

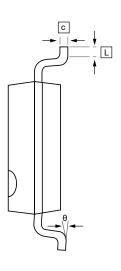
Special note: When the resistance capacitance step-down circuit is used to supply power to ULN2001D, because the resistance capacitance step-down voltage cannot prevent the transient high-voltage fluctuation on the grid, a 104 capacitor must be connected to the COM terminal and the ground terminal of ULN2001D, as shown in Figure 10. In other applications, this capacitor does not need to be added.



## 12.SOP-8 Package Outline Dimensions







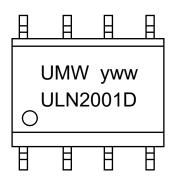
#### **DIMENSIONS** (mm are the original dimensions)

Symbol	Α	<b>A</b> 1	A2	b	С	D	E	E1	е	L	θ
Min	1.350	0.000	1.350	0.330	0.170	4.700	3.800	5.800	1.270	0.400	0°
Max	1.750	0.100	1.550	0.510	0.250	5.100	4.000	6.200	BSC	1.270	8°



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## 13.Ordering Information



yww: Batch Code

Order Code	Package	Base QTY	Delivery Mode		
UMW ULN2001D	SOP-8	2500	Tape and reel		

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#### 14.Disclaimer

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